Philips Semiconductors

Product Specification

PowerMOS transistor

BUK436-100A/B

GENERAL DESCRIPTION

N-channel enhancement mode

rectainer ennancement mode field-effect power transistor in a plastic envelope.

The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in concept purpose converters. in general purpose switching applications.

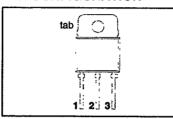
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
V _{DS} I _D P _{tot} R _{DS(ON)}	BUK436 Drain-source voltage Drain current (DC) Total power dissipation Drain-source on-state resistance	-100A 100 33 125 0.057	-100B 100 31 125 0.065	> A & Q

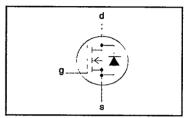
PINNING - SOT93

PIN	DESCRIPTION
1	gate
2	drain
3	source
tab	drain

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	M/	UNIT	
V _{DS} V _{DGR} ±V _{GS}	Drain-source voltage Drain-gate voltage Gate-source voltage	$R_{GS} = 20 \text{ k}\Omega$	-	100 100 30		V
I _D I _D	Drain current (DC) Drain current (DC) Drain current (pulse peak value)	T _{mb} = 25 °C T _{mb} = 100 °C T _{mb} = 25 °C	-	-100A 33 20 132	-100B 31 19 124	A A A
P _{tot} T _{stg} T _i	Total power dissipation Storage temperature Junction Temperature	T _{mb} = 25 °C	- 55	125 150 150		o So M

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j mb}	Thermal resistance junction to mounting base		-	-	1.0	K/W
R _{th j-a}	Thermal resistance junction to ambient		-	45	-	K/W

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STATIC CHARACTERISTICS

T_{mb} = 25 'C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V; } I_D = 0.25 \text{ mA}$	100	-	-	٧
V _{GS(TO)}	Gate threshold voltage	$V_{DS} = V_{GS}$; $I_D = 1 \text{ mA}$	2.1	3.0	4.0	٧
Ipss	Zero gate voltage drain current	$V_{0S} = 100 \text{ V}$; $V_{GS} = 0 \text{ V}$; $T_i = 25 \text{ C}$	-	1	10	μA
Ipss	Zero gate voltage drain current	V _{os} = 100 V; V _{os} = 0 V; T _i = 25 °C V _{os} = 100 V; V _{os} = 0 V; T _j = 125 °C	-	0.1	1.0	mΑ
IGSS	I Gate source leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
R _{DS(ON)}	Drain-source on-state	V _{GS} = 10 V; BUK436-100A	-	0.052	0.057	Ω
03(014)	resistance	I _D = 15 A BUK436-100B	-	0.06	0.065	Ω

DYNAMIC CHARACTERISTICS

Tmb = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g _{fs}	Forward transconductance	$V_{DS} = 25 \text{ V}; I_{D} = 15 \text{ A}$	12	16	-	S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Feedback capacitance	$V_{GS} = 0 \text{ V; } V_{DS} = 25 \text{ V; } f = 1 \text{ MHz}$	-	1500 450 130	2000 600 200	<u></u> ት ት ት ት
tdon tr tdoff tr	Turn-on delay time Turn-on rise time Turn-off delay time Turn-off fall time	$\begin{array}{l} V_{DD} = 30 \text{ V; } I_D = 3 \text{ A;} \\ V_{GS} = 10 \text{ V;} \\ R_{gen} = 50 \Omega; \\ R_{GS} = 50 \Omega \end{array}$:	20 40 150 65	30 60 200 85	ns ns ns ns
L _d	Internal drain inductance Internal drain inductance	Measured from contact screw on tab to centre of die Measured from drain lead 6 mm from package to centre of die	-	5 5	-	nH nH
L _s	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	12.5	-	nН

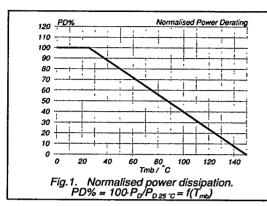
REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

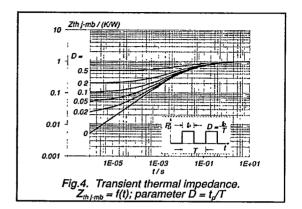
Tmb = 25 °C unless otherwise specified

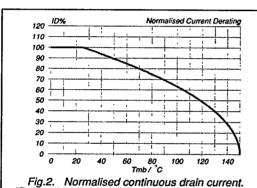
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{DR}	Continuous reverse drain current	-	-	-	33	Α
I _{DRM} V _{SD}	Pulsed reverse drain current Diode forward voltage	$I_F = 33 \text{ A}$; $V_{GS} = 0 \text{ V}$	<u>-</u>	1.4	132 1.7	Ŷ
t, Q,	Reverse recovery time Reverse recovery charge	$I_F = 33 \text{ A}$; $-dI_F/dt = 100 \text{ A/}\mu\text{s}$; $V_{GS} = 0 \text{ V}$; $V_R = 30 \text{ V}$	-	100 1.0	-	ns μC

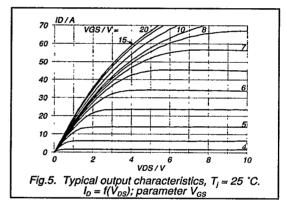
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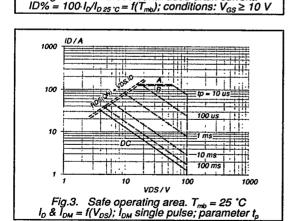
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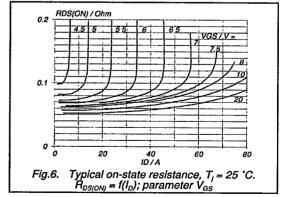








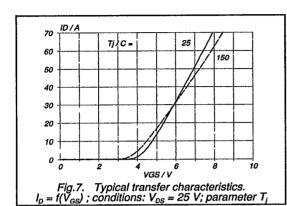


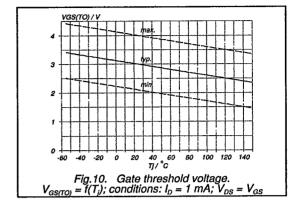


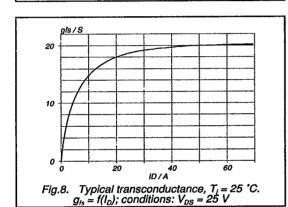
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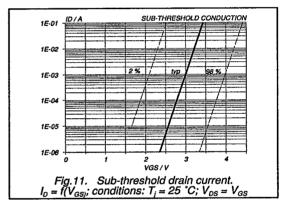
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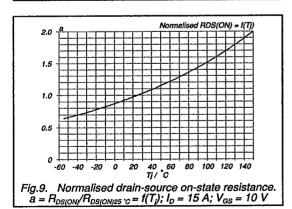
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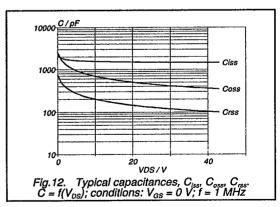












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